

A 44th Symposium Summary from Chapter President, Jon Medernach



Sincerest thanks to all!

It is extremely gratifying when you put your best efforts into an endeavor and it is successful. By all accounts the iMAPS New England 44th Symposium and Expo was an overwhelming success! Technical Chairs, Parshant Kumar of Draper and Dmitry Marchenko of BAE, assembled an outstanding program that was both informative and diverse drawing interest from all corners of the microelectronics world.

Kudos to our Sessions Chairs for crafting a wonderful program; **RF & Microwave Session** – Tom Terlizzi and Chandra Gupta, **Printed Electronics** – Katherine Duncan and Craig Armiento, **Nanoelectronics & Optoelectronics** – Yi Qian and Jin Li, **Medical Device Packaging** – Caroline Bjune and Steve LaFerriere, **MEMS & Nano Systems** – Robert D. White and Rick Morrison, **Thermal Management** - Dave Saums and **Poster Session** – Tom Marinis and Amaresh Mahapatra.

A special thanks to Keynote Speaker, Dr. Livia M. Racz of MIT Lincoln Labs, for sharing her most pertinent and insightful presentation on the current state of development and innovation in our industry. It was outstanding and you'll find it soon on our website: <http://www.imapsne.org/>

The Expo was sold out once again with 55 satisfied exhibitors. Exhibits Chair Michael Toro and I visited each booth and were pleased with all of the positive feedback. They were impressed with the quality of the attendees, the affordability and the organization of the event. I am sure we will sell out again next year so, consider taking advantage of the Early Bird Special on our website to secure a space and to save some money!

In addition to vendors supporting the chapter by exhibiting, a special group supports us at a higher level, our **GOLD Sponsors!** **MRSI Systems, LLC, Mini-Systems, Stellar Industries, Riv, Geib Refining Corp, TJ Green Associates, Technic Inc,** and our **Silver Sponsor Metallix**

I don't have a final count of attendees but the sessions were well attended and exhibitors were pleased with traffic on the expo floor. We thank all participants for their support of our Chapter.

This "one day" event is the culmination of months of planning and work by the New England Chapter Executive Committee. I would be remiss in not thanking; Amaresh Mahapatra, Rozalia Beica, Dmitry Marchenko, Harvey Smith, Judi Eicher, Jim McLenaghan, Joe Soucy, John Blum, John Redman, Jeremy Lug, Matt Bracy, Michael Gervais, Michael Toro, Minh Tran, Parshant Kumar, Tom Marinis, and Rita Mohanty for your time and efforts in carrying out the iMAPS Mission;

"iMAPS leads the Microelectronics Packaging, Interconnect and Assembly Community, providing means of communicating, educating and interacting at all levels."

Thank you for your support.

Jon Medernach, President, iMAPS New England